



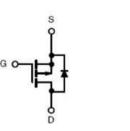
MJ P-Channel Enhancement Mode Power MOSFET

Description

The MJ40P70K uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge . This device is well suited for high current load applications.

General Features

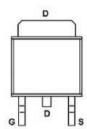
- ◆ V_{DS} =-40V.I_D =-70A $R_{DS(ON)}$ <10m Ω @ Vgs=-10V
- ◆ High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability





Application

- ◆ Power switch
- Load switch in high current applications
- ◆ DC/DC converters







TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ40P70K	MJ40P70K	TO-252-2L	330mm	_	2500PCS

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	-70	А
Drain Current-Continuous(Tc =100℃)	I D(100℃)	-49.5	А
Pulsed Drain Current	IDM	-200	А
Maximum Power Dissipation	Po	130	W
Derating factor		1.04	W/°C
Single pulse avalanche energy (Note 5)	Eas	1012	mJ
Operating Junction and Storage Temperature Range	Тл ,Тѕтс	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2) ReJC 0.96 °C/W	Thermal Resistance,Junction-to-Case (Note 2)	Rejc	0.96	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =-250μA	-40	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =-40V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	Vps=Vgs ,lp=-250μA	-1.2	-1.9	-2.5	V
Drain-Source On-State Resistance	Rds(on)	Vgs=-10V, Ip=-20A	_	7.5	10	mΩ
Forward Transconductance	g FS	V _{DS} =-10V,I _D =-20A	_	50	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss		-	5380	-	PF
Output Capacitance	Coss	V _{DS} =-20V,V _{GS} =0V F=1.0MHz	_	570	-	PF
Reverse Transfer Capacitance	Crss		_	500	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	15	-	nS
Turn-on Rise Time	tr	V _{DD} =-20V, R _L =2Ω	_	12	-	nS
Turn-Off Delay Time	t _{d(off)}	V _{GS} =-10V,R _G =1Ω	_	70	-	nS
Turn-Off Fall Time	tf	-	-	18	-	nS
Total Gate Charge	Qg		-	106	-	nC
Gate-Source Charge	Qgs	V _{DS} =-20V,I _D =-20A V _{GS} =-10V	_	22	-	nC
Gate-Drain Charge	Qgd	_	-	27	-	nC
Drain-Source Diode Characteristics						<u> </u>
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =-70A	_	-	-1.2	V
Diode Forward Current (Note 2)	Is		_	-	-70	А
Reverse Recovery Time	trr	TJ=25°C, IF=-70A	-	53	-	nS
Reverse Recovery Charge	Qrr	di/dt=-100A/µs (Note 3)	_	50	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible(turn-on is dominated by LS				

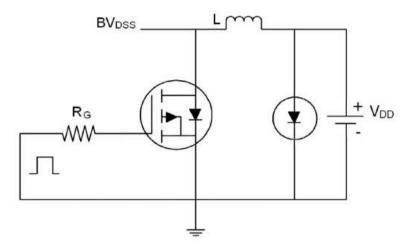
Notes:

- $\ensuremath{\textcircled{\scriptsize 1}}$ Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3 Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- $\boxed{5}$ EAS condition: Tj=25°C,VDD=-20V,VG=-10V,L=1mH,Rg=25 Ω ,IAS=45A

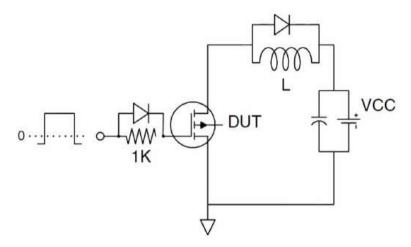




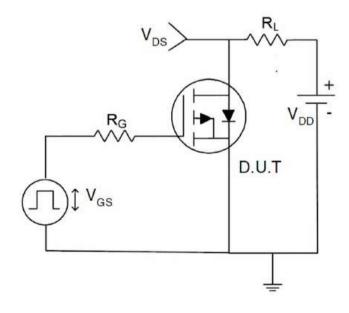
Test circuit



Eas test Circuit



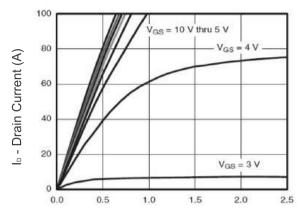
Gate charge test Circuit



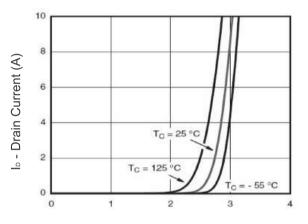
Switch Time Test Circuit



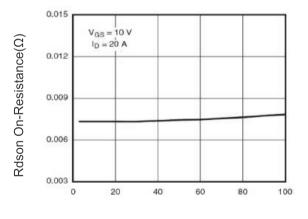
Typical Electrical and Thermal Characteristics (Curves)



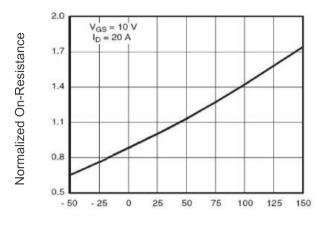




Vgs Gate-Source Voltage (V) Figure 2 Transfer Characteristics

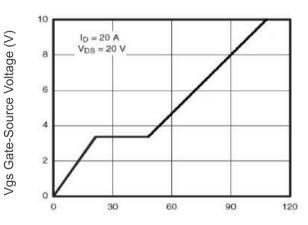


ID - Drain Current (A) Figure 3 Rdson- Drain Current

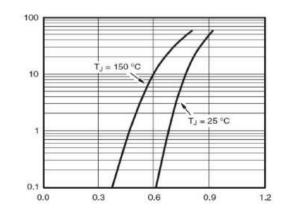


T_J -Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



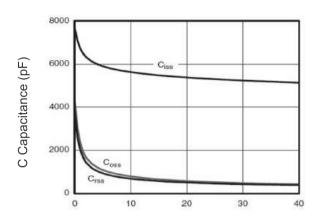
Qg Gate Charge (nC) Figure 5 Gate Charge



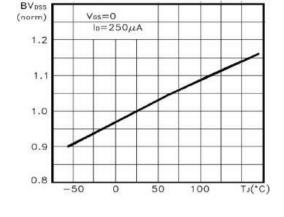
Vsd Source-Drain Voltage (V) Figure 6 Source- Drain Diode Forward

Is - Reverse Drain Current (A)

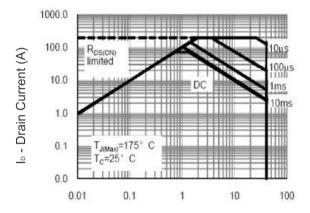




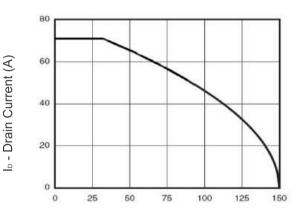
Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



T_J -Junction Temperature(°C)
Figure 9 BV_{DSS} vs Junction Temperature



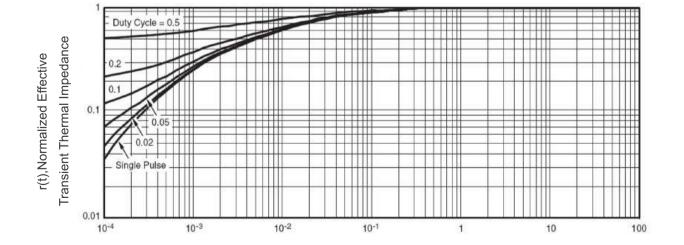
Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T_J -Junction Temperature(°C)

Figure 10 I_D Current Derating vs Junction

Temperature



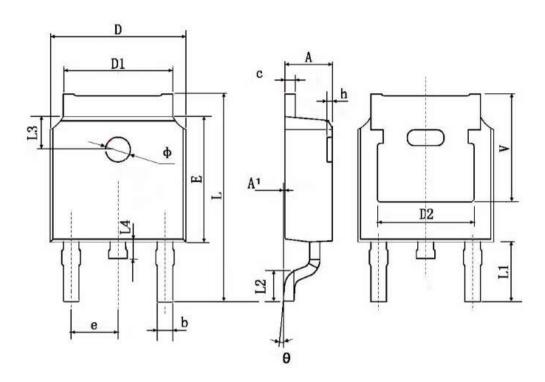
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2,386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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